



## DESCRIPTION

The AM8205 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

AM8205 is available in a TSSOP8 and SOT-26 packages.

## ORDERING INFORMATION

Package Type	Part Number	
TSSOP8	TMX8	AM8205TMX8R
		AM8205TMX8VR
SOT-26	E6	AM8205E6R
		AM8205E6VR
Note	V: Halogen free Package R: Tape & Reel	
AiT provides all RoHS products Suffix " V " means Halogen free Package		

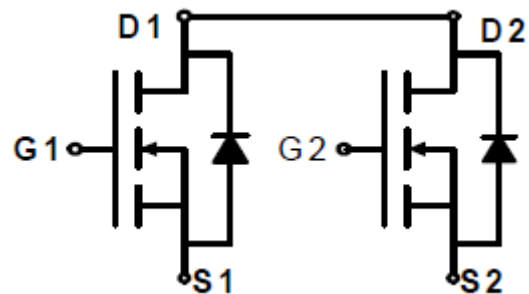
## FEATURES

- $V_{DS} = 20V$ ,  $I_D = 6A$
- $R_{DS(ON)} < 22m\Omega @ V_{GS} = 4.5V$
- $R_{DS(ON)} < 27m\Omega @ V_{GS} = 2.5V$
- High Power and current handling capability
- Lead free product is acquired
- Surface Mount Package
- Available in a TSSOP8 and SOT-26 packages.

## APPLICATION

- Battery protection
- Load switch
- Power management

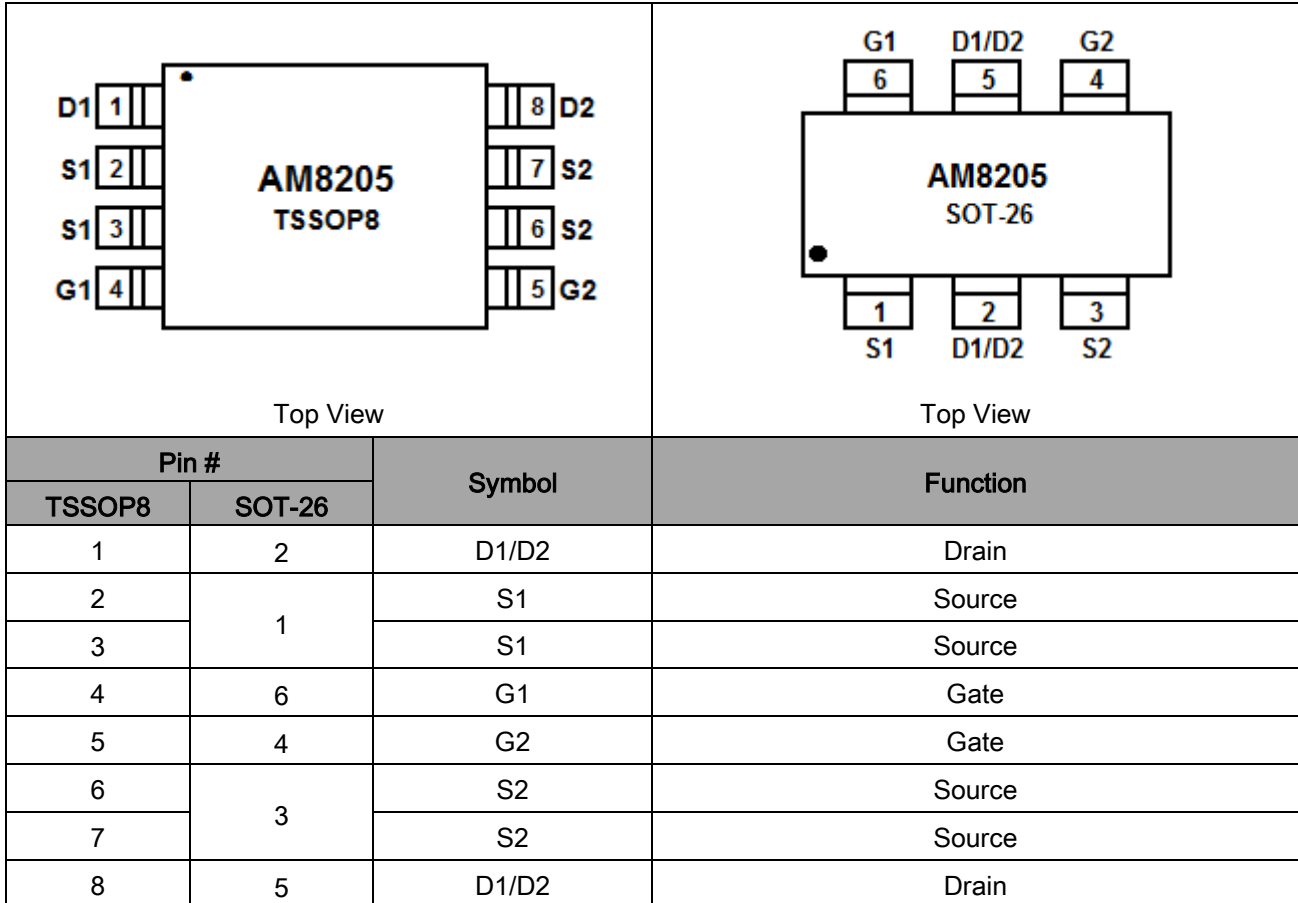
## PIN DESCRIPTION



Schematic diagram



**PIN DESCRIPTION**





## ABSOLUTE MAXIMUM RATINGS

T<sub>A</sub> = 25°C, unless otherwise noted

V <sub>DS</sub> , Drain-Source Voltage	20V
V <sub>GS</sub> , Gate-Source Voltage	±12V
I <sub>D</sub> , Drain Current-Continuous	6A
I <sub>DM</sub> , Drain Current-Pulsed <sup>NOTE1</sup>	25A
P <sub>D</sub> , Maximum Power Dissipation	1.5W
T <sub>J</sub> , T <sub>STG</sub> , Operating Junction and Storage Temperature Range	-55°C~150°C

Stress beyond above listed "Absolute Maximum Ratings" may lead permanent damage to the device. These are stress ratings only and operations of the device at these or any other conditions beyond those indicated in the operational sections of the specifications are not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL CHARACTERISTICS

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Ambient <sup>NOTE2</sup>	R <sub>θJA</sub>	83	°C/W



## ELECTRICAL CHARACTERISTICS

T<sub>A</sub> = 25°C, unless otherwise noted

Parameter	Symbol	Conditions	Min	Typ.	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	20	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V	-	-	±100	nA
<b>On Characteristics</b> NOTE3						
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.5	0.7	1.2	V
Drain-Source On-state Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4.5A	-	16	22	mΩ
		V <sub>GS</sub> =2.5V, I <sub>D</sub> =3.5A	-	19	27	
Forward Transconductance	g <sub>FS</sub>	V <sub>DS</sub> =5V, I <sub>D</sub> =4.5A	-	10	-	S
<b>Dynamic Characteristics</b> NOTE4						
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> =10V, V <sub>GS</sub> =0V, F=1.0MHz	-	900	-	pF
Output Capacitance	C <sub>OSS</sub>		-	220	-	
Reverse Transfer Capacitance	C <sub>RSS</sub>		-	100	-	
<b>Switching Characteristics</b> NOTE4						
Turn-on Delay Time	t <sub>D(ON)</sub>	V <sub>DD</sub> =10V, I <sub>D</sub> =1A, V <sub>GS</sub> =4.5V, R <sub>GEN</sub> =6Ω	-	10	20	ns
Turn-on Rise Time	t <sub>R</sub>		-	11	25	
Turn-off Delay Time	t <sub>D(OFF)</sub>		-	35	70	
Turn-off Fall Time	t <sub>F</sub>		-	30	60	
Total Gate Charge	Q <sub>G</sub>	V <sub>DS</sub> =10V, I <sub>D</sub> =6A, V <sub>GS</sub> =4.5V	-	12	15	nC
Gate-Source Charge	Q <sub>GS</sub>		-	2.3	-	
Gate-Drain Charge	Q <sub>GD</sub>		-	1	-	
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =1.7A	-	0.75	1.2	V
Diode Forward Current	I <sub>S</sub>		-	-	1.7	A

NOTE1: Repetitive Rating: Pulse width limited by maximum junction temperature.

NOTE2: Surface Mounted on FR4 Board, t ≤ 10 sec.

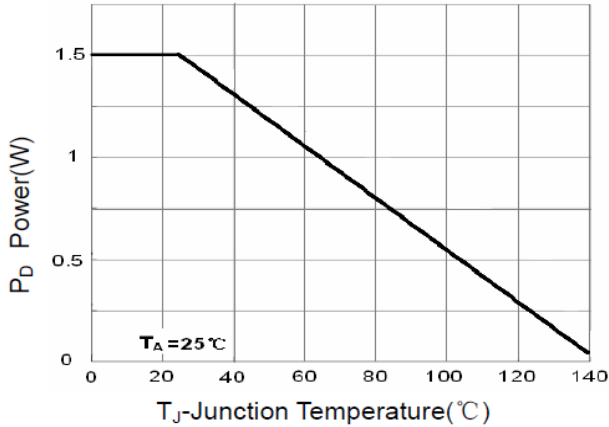
NOTE3: Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.

NOTE4: Guaranteed by design, not subject to production

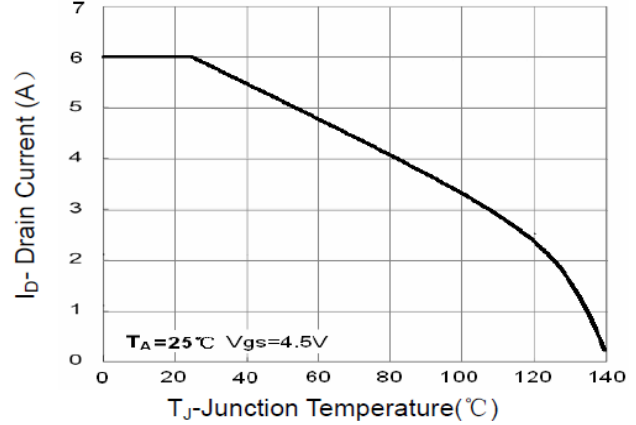


## TYPICAL CHARACTERISTICS

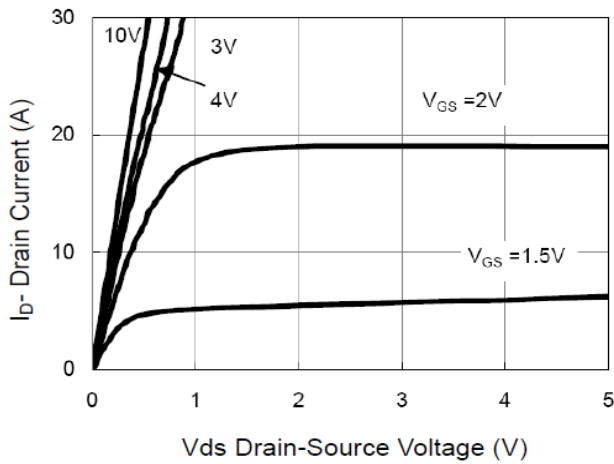
1. Power Dissipation



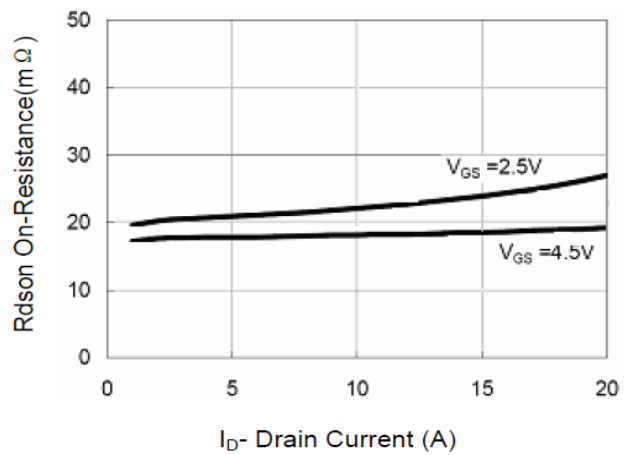
2. Drain Current



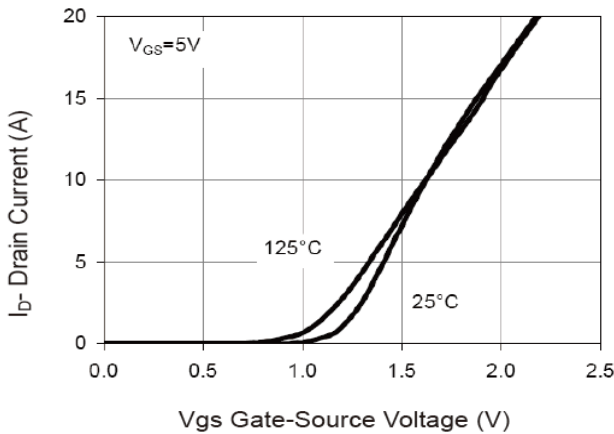
3. Output Characteristics



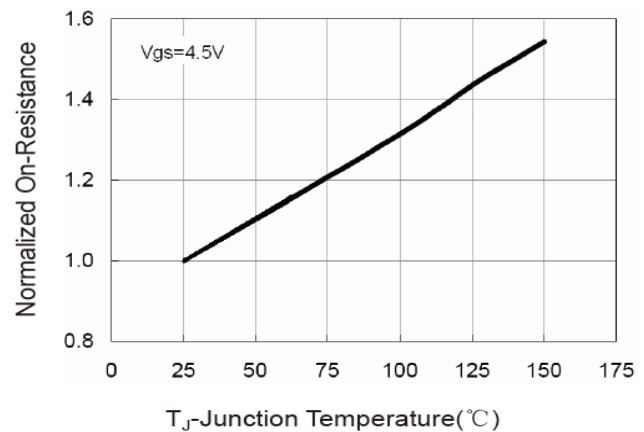
4. Drain-Source On-Resistance



5. Transfer Characteristics

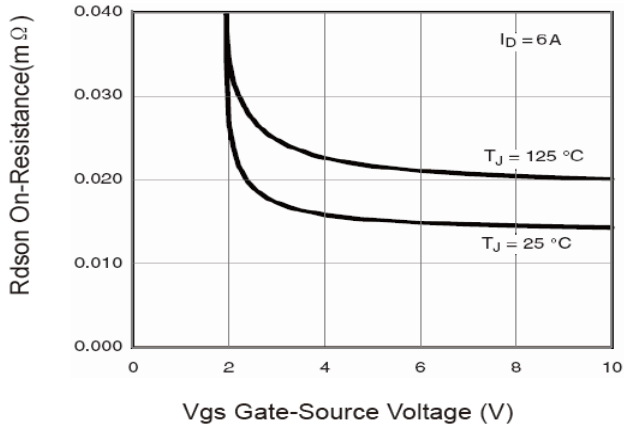


6. Drain-Source On-Resistance

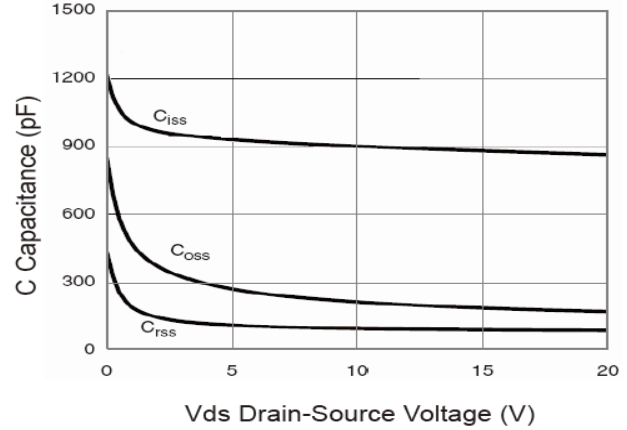




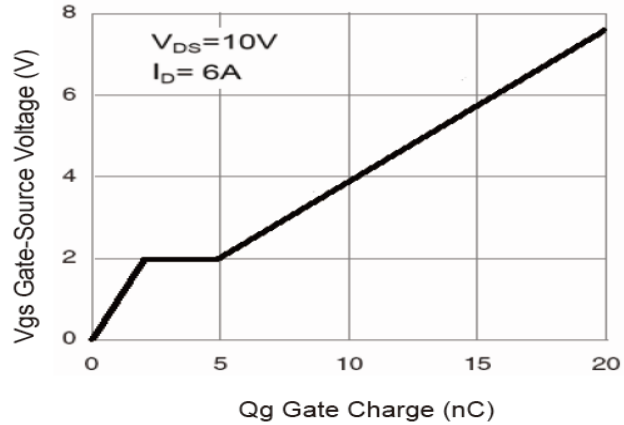
7.  $R_{DS(on)}$  vs.  $V_{GS}$



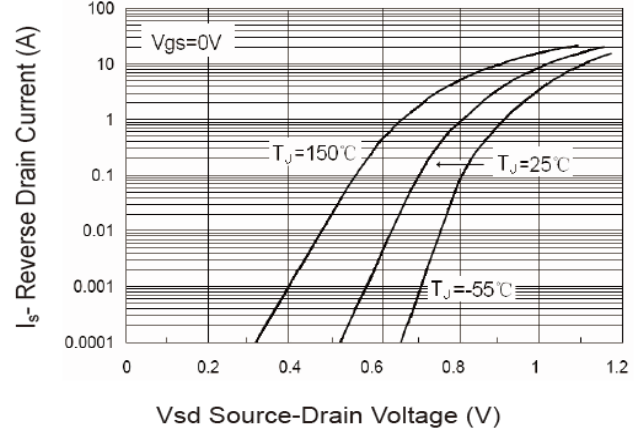
8. Capacitance vs.  $V_{DS}$



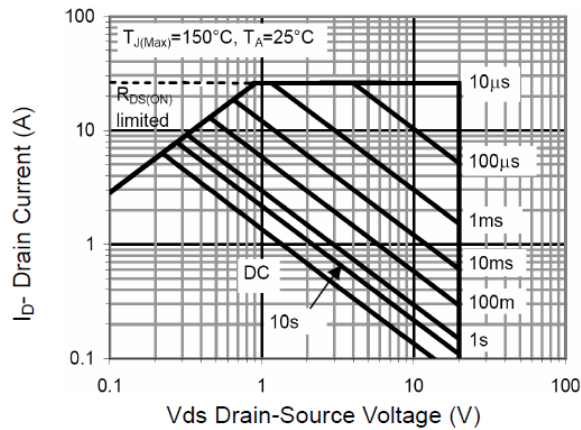
9. Gate Charge



10. Source- Drain Diode Forward

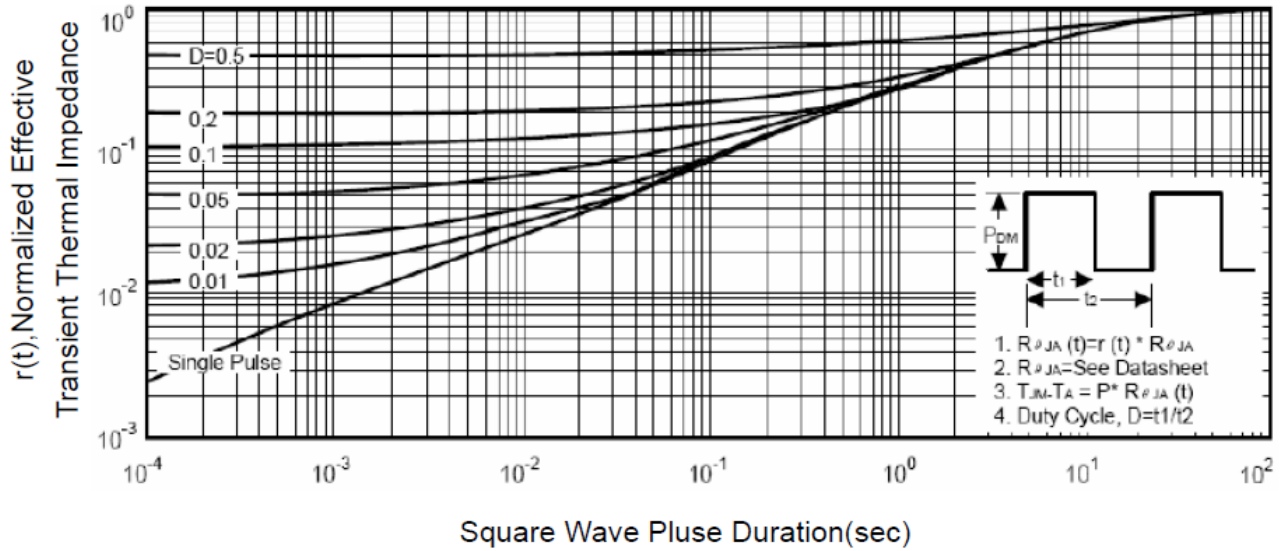


11. Safe Operation Area



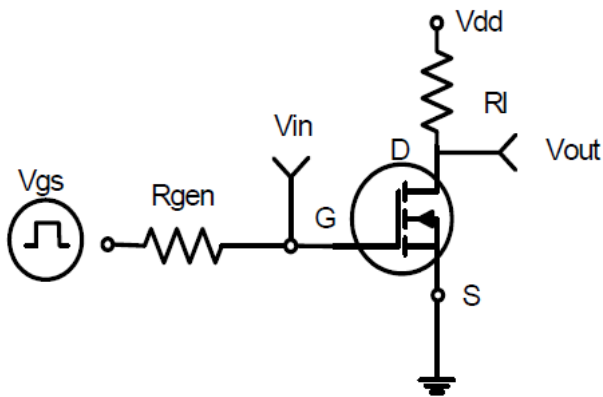


### 12. Normalized Maximum Transient Thermal Impedance

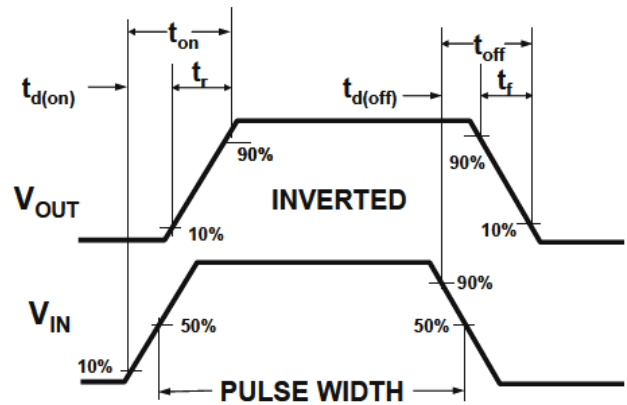


### DETAILED INFORMATION

#### 1. Switching Test Circuit



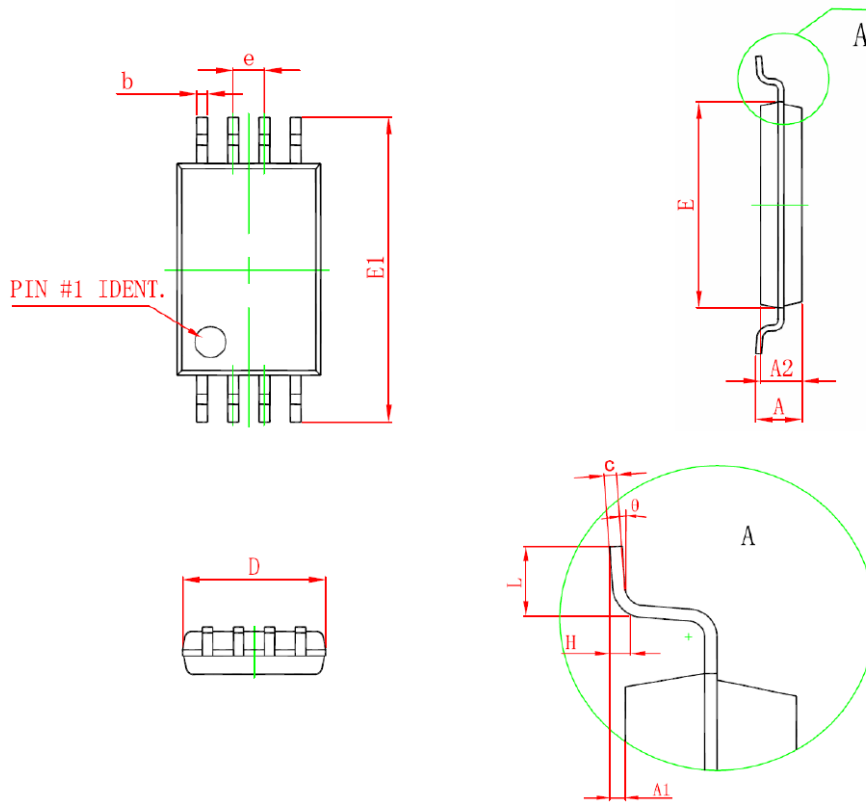
#### 2. Switching Waveforms





**PACKAGE INFORMATION**

Dimension in TSSOP8 (Unit: mm)

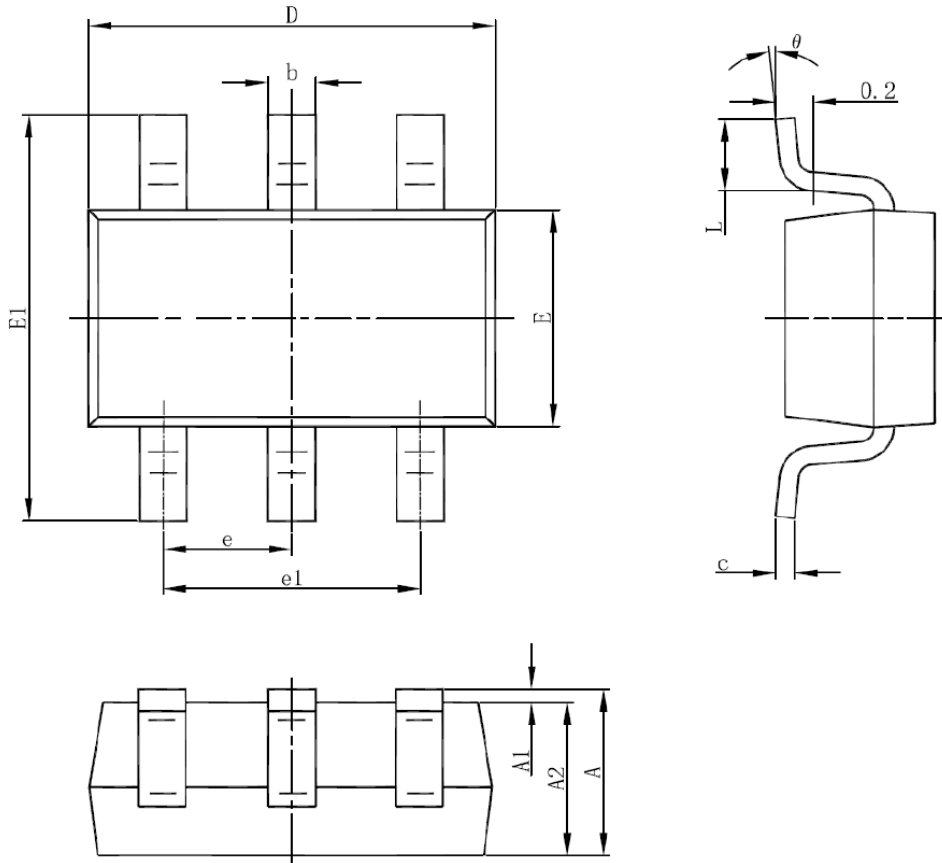


Symbol	Min	Max
D	2.900	3.100
E	4.300	4.500
b	0.190	0.300
c	0.090	0.200
E1	6.250	6.550
A	-	1.100
A2	0.800	1.000
A1	0.020	0.150
e	0.650(BSC)	
L	0.500	0.700
H	0.250(TYP)	
$\theta$	1°	7°





Dimension in SOT-26(Unit: mm)



Symbol	Min	Max
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.300	0.500
c	0.100	0.200
D	2.820	3.020
E	1.500	1.700
E1	2.650	2.950
e	0.950(BSC)	
E1	1.800	2.000
L	0.300	0.600
$\theta$	0°	8°



## IMPORTANT NOTICE

AiT Semiconductor Inc. (AiT) reserves the right to make changes to any its product, specifications, to discontinue any integrated circuit product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

AiT Semiconductor Inc.'s integrated circuit products are not designed, intended, authorized, or warranted to be suitable for use in life support applications, devices or systems or other critical applications. Use of AiT products in such applications is understood to be fully at the risk of the customer. As used herein may involve potential risks of death, personal injury, or severe property, or environmental damage. In order to minimize risks associated with the customer's applications, the customer should provide adequate design and operating safeguards.

AiT Semiconductor Inc. assumes to no liability to customer product design or application support. AiT warrants the performance of its products of the specifications applicable at the time of sale.